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System SourceMeter Instrument Specifications

SPECIFICATION CONDITIONS

This document contains specifications and supplemental information for the Model 2606B System SourceMeter[®] instrument. Specifications are the standards against which the 2606B instruments are tested. Upon leaving the factory, the 2606B instruments meet these specifications. Supplemental and typical values are nonwarranted, apply at 23 °C, and are provided solely as useful information. Specifications are for individual modules.

Source and measurement accuracies are specified at the 2606B terminals under these conditions:

- 1. 23 °C ±5 °C, < 70 percent relative humidity
- 2. After a two-hour warm-up period
- 3. Speed normal (1 NPLC)
- 4. A/D autozero enabled
- 5. Remote sense operation or properly zeroed local operation
- 6. Calibration period: One year

DC POWER SPECIFICATIONS



-3A -20V -6V 0V +6V +20V

Specifications are subject to change without notice

-1 A

¹ For additional power derating information for various load and temperature conditions, refer to "Operating Boundaries" in the Series 2606B Reference Manual.

² The System SourceMeter[®] will allow quadrant II and quadrant IV operation, however, it is intended for low power or short transient behavior. Operation in quadrant II and quadrant IV could result in an overtemperature error.

VOLTAGE ACCURACY SPECIFICATIONS^{3, 4}

	Source		Measure	Measure		
	Programming resolution	Accuracy ± (% reading + volts)	Typical noise (peak to peak)	Display resolution	Accuracy⁵ ± (% reading + volts)	
Range			0.1 Hz to 10 Hz			
100 mV	5 µV	0.02% + 250 μV	20 µV	100 nV	0.015% + 150 μV	
1 V	50 µV	0.02% + 400 µV	50 μV	1 μV	0.015% + 200 μV	
6 V	50 µV	0.02% + 1.8 mV	100 µV	1 μV	0.015% + 1 mV	
20 V	500 μV	0.02% + 12 mV	500 μV	10 µV	0.015% + 8 mV	

CURRENT ACCURACY SPECIFICATIONS³

	Source		Measure		
	Programming resolution	Accuracy ± (% reading + amperes)	Typical noise (peak to peak)	Display resolution	Accuracy ⁵ ± (% reading + amperes)
Range			0.1 Hz to 10 Hz		
100 nA	2 pA	0.06% + 100 pA	5 pA	100 fA	0.05% + 100 pA
1 µA	20 pA	0.03% + 800 pA	25 pA	1 pA	0.025% + 500 pA
10 µA	200 pA	0.03% + 5 nA	60 pA	10 pA	0.025% + 1.5 nA
100 µA	2 nA	0.03% + 60 nA	3 nA	100 pA	0.02% + 25 nA
1 mA	20 nA	0.03% + 300 nA	6 nA	1 nA	0.02% + 200 nA
10 mA	200 nA	0.03% + 6 µA	250 nA	10 nA	0.02% + 2.5 μA
100 mA	2 µA	0.03% + 30 µA	600 nA	100 nA	0.02% + 20 μA
1 A	20 µA	0.05% + 1.8 mA	70 µA	1 µA	0.03% + 1.5 mA
3 A	20 µA	0.06% + 4 mA	150 µA	1 µA	0.05% + 3.5 mA

 4 Add 50 μ V to source accuracy specifications per volt of HI lead drop.

 ⁵ Derate accuracy specification for NPLC setting < 1 by increasing the error term. Add appropriate typical percent of reading term for resistive loads using the table below.

NPLC setting	100 mV range	1 V and 40 V ranges	100 nA range	1 µA to 100 mA ranges	1 A to 3 A ranges
0.1	0.01%	0.01%	0.01%	0.01%	0.01%
0.01	0.08%	0.07%	0.1%	0.05%	0.05%
0.001	0.8%	0.6%	1%	0.5%	1.1%

³ For temperatures 0 °C to 18 °C and 28 °C to 50 °C, accuracy is degraded by ±(0.15 × accuracy specification)/°C.

SUPPLEMENTAL CHARACTERISTICS

The following specifications are supplemental characteristics that provide additional information about instrument functions and performance. These characteristics are nonwarranted specifications; they describe the typical performance of the 2606B.

ADDITIONAL SOURCE CHARACTERISTICS

Noise	< 20 mV peak-peak, < 3 mV _{RMS}					
10 Hz to 20 MHz	6 V range					
Minimum programmable	100 µs					
pulse width ^{•,}	Note: Minimum pulse width for settled source at a given I/V output and load can be longer than 100 ms.					
	Source value	Load	Source settling time (% of range)	Minimum pulse width		
	6 V	2 Ω	0.2%	150 µs		
	3 A	2 Ω	0.2%	150 µs		
Pulse width programming resolution	1 µs					
Pulse width programming accuracy	±5 µs					
Pulse width jitter	2 µs					
Transient response time	< 70 µs for the output to recover to within 0.1% for a 10% to 90% step change in load.					
Overshoot	Voltage:					
	< ±0.1% of rar	nge + 10 mV				
	Step size = 10% to 90% of range, resistive load, maximum current limit/compliance					
	Current:					
	< ±0.1% of rar	nge				
	 Step size = 10% to 90% of range, resistive load 					
	See <u>Current s</u>	ource output settling	time for additional test cor	nditions		
Range change overshoot		404 61				
	< 300 mV + 0.	.1% of larger range	MHz boodwidth			
	- Overshoot mit	5 a 100 ks2 10au, 20 1				
	$\sim 200 \text{ m}//\text{P}_{\odot}$		200			
Guard offset voltage	- < 300 mV/RL0	AD + 5 % OF larger fai	ige			
Guard onset voltage	• Current < 10 r	mΔ				
Remote sense operating	Maximum voltage	between HI and SEN	NSE HI = 3 V			
range ⁸	Maximum voltago	between I O and SE	NSE $I \cap = 3 V$			
	waximum voitage	Detween LO and SE	10 = 3			

⁶ Times measured from the start of pulse to the start off-time; see figure below.



⁷ With source settling set to SETTLE_SMOOTH_100NA

 8 Add 50 μV to source accuracy specifications per volt of HI lead drop.

Specifications are subject to change without notice

Voltage output headroom	20 V range				
	 Maximum output voltage = 22 V – (tota Maximum 1 Ω source lead. 	al voltage drop across source leads).			
	6 V range				
	 Maximum output voltage = 8 V – (total voltage drop across source leads). Maximum 1 Ω source lead. 				
Overtemperature protection	Internally sensed temperature overload put	ts the instrument in standby mode			
Limit/compliance	Bipolar limit (compliance) set with a single	value			
	Voltage:				
	 Minimum value is 10 mV; accuracy is 	the same as voltage source			
	Current:				
	 Minimum value is 10 nA; accuracy is the second secon	he same as current source			
Voltage source output settling time	Time required to reach within 0.1% of final value after source level command i processed on a fixed range.				
	Voltage range	Settling time			
	100 mV	< 50 µs			
	1 V	< 50 µs			
	10 V	< 110 µs			
	20 V ⁹	< 150 µs			
Current source output settling time	Time required to reach within 0.1% of final processed on a fixed range	value after source level command is			
	 Values below for Iout × RLOAD = 1 V 				
	Current range	Settling time			
	3 A	< 80 μ s (Current < 2.5 A, R _{LOAD} > 2 Ω)			
	1 A to 10 mA	< 80 μs (R _{LOAD} > 6 Ω)			
	1 mA	< 100 µs			
	100 µA	< 150 µs			
	10 µA	< 500 µs			
	1 μΑ	< 2 ms			
	100 nA	< 20 ms			

ADDITIONAL MEASUREMENT CHARACTERISTICS

Current measure settling time ¹⁰	Time required to reach within 0.1% of final value after source level command is processed on a fixed range		
	Values below for Vout = 1 V		
	Current range	Settling time	
	1 mA	< 100 µs	
Input impedance	> 10 GΩ		

 $^{^9}$ Add 150 μs when measuring on the 1 A range. 10 Compliance equal to 100 mA

ADDITIONAL CHARACTERISTICS

Maximum load impedance	Normal mode	High-capacitance mode	
	10 nF	50 µF	
Common mode voltage	250 VDC		
Common mode isolation	> 1 GΩ		
	< 4500 pF		
Sense high input impedance	> 10 GΩ		
Maximum sense lead resistance	1 kΩ for rated accuracy		
Overrange	101% of source range		
	102% of measure range		

MEASUREMENT SPEED CHARACTERISTICS^{11,12}

Maximum sweep operation rates (operations per second) for 60 Hz (50 Hz):

A/D converter speed	Trigger origin	Measure to memory	Measure to USB	Source measure to memory	Source measure to USB	Source measure to memory	Source measure to USB
(NPLC)		(using user scripts)	(using user scripts)	(using user scripts)	(using user scripts)	(using sweep API)	(using sweep API)
0.001	Internal	20000 (20000)	9800 (9800)	7000 (7000)	6200 (6200)	12000 (12000)	5900 (5900)
0.001	Digital I/O	8100 (8100)	7100 (7100)	5500 (5500)	5100 (5100)	11200 (11200)	5700 (5700)
0.01	Internal	4900 (4000)	3900 (3400)	3400 (3000)	3200 (2900)	4200 (3700)	4000 (3500)
0.01	Digital I/O	3500 (3100)	3400 (3000)	3000 (2700)	2900 (2600)	4150 (3650)	3800 (3400)
0.1	Internal	580 (480)	560 (470)	550 (465)	550 (460)	560 (470)	545 (460)
0.1	Digital I/O	550 (460)	550 (460)	540 (450)	540 (450)	560 (470)	545 (460)
1.0	Internal	59 (49)	59 (49)	59 (49)	59 (49)	59 (49)	59 (49)
1.0	Digital I/O	59 (49)	59 (49)	59 (49)	59 (49)	59 (49)	59 (49)

 ¹¹ Tests performed using the following equipment: Computer hardware — Intel[®] Core[™] i7 at 2.90 GHz, 8 GB RAM; software — Microsoft[®] Windows[®] 10 Enterprise 64-bit, Microsoft[®] Visual Studio[®] 2010, VISA[™] version 5.8.
 ¹² Exclude current measurement ranges less than 1 mA.

A/D converter speed (NPLC)	d Trigger origin		Measure to USB	Source measure to USB	Source measure pass/fail to USB	
0.001	Intern	al	1900 (1800)	1400 (1400)	1400 (1400)	
0.01	Intern	al	1450 (1400)	1200 (1200)	1100 (1100)	
0.1	Intern	al	450 (390)	425 (370)	425 (375)	
1.0	Intern	al	58 (48)	57 (48)	57 (48)	
Maximum measurement range change rate		> 7000 per second for > 10 μ A. When changing to or from a range ≥ 1 A, maximum rate is > 2200 per second.				
Maximum source range change rate		> 400 per second > 10 μ A. When changing to or from a range ≥ 1 A, maximum rate is > 190 per second.				
Maximum source function change rate		> 1000 per second				
Command processing time		< 1 ms				
		 Maximum time required for the output to begin to change after receiving the smua.source.levelv or smua.source.leveli command. 				

Maximum single measurement rates (operations per second) for 60 Hz (50 Hz)

TRIGGERING AND SYNCHRONIZATION CHARACTERISTICS

Triggering

Trigger in to trigger out	0.5 µs
Trigger in to source change ¹³	10 µs
Trigger timer accuracy	±2 µs
Source change ¹³ after LXI trigger	280 µs

Synchronization

Multi-node synchronized source change ¹³	< 0.5 µs
Single-node synchronized source change ¹³	< 0.5 µs

¹³ Fixed source range with no polarity change.

SUPPLEMENTAL INFORMATION

Programming	 Embedded Test Script Processor (TSP[®]) scripting engine is accessible from any host interface: Responds to individual instrument control commands Responds to high-speed test scripts comprised of remote commands and test script language (TSL) statements (for example, branching, looping, and math) Able to execute high-speed test scripts stored in memory without host intervention
Minimum user memory available	16 MB (approximately 250,000 lines of TSP code)
Test Script Builder	Integrated development environment for building, running, and managing TSP scripts; includes an instrument console for interactive communication with any TSP-enabled instrument. For information on requirements, refer to the Test Script Builder documentation, available at <u>tek.com/keithley</u> .
Software interface	Read/write with tools such as Microsoft [®] Visual Basic [®] , Visual C/C++ [®] , Visual C# [®] , LabVIEW™, CEC TestPoint™ Data Acquisition Software Package, and NI LabWindows™/CVI.
Reading buffers	 Nonvolatile memory uses dedicated storage areas reserved for measurement data. Reading buffers are arrays of measurement elements. Each element can store the following items: Measurement Source setting (at the time the measurement was taken) Measurement status Range information Timestamp Reading buffers can be filled using the front-panel STORE key, and retrieved using the RECALL key or host interface.
Buffer size, with timestamp and source setting	> 60,000 samples
Buffer size, without timestamp and source setting	> 140,000 samples

System expansion	The TSP-Link expansion interface allows TSP-enabled instruments to trigger and communicate with each other. See the figure below.
	Node 1 Node 2
	The 2606B has four TSP-Link connectors (two on each module) to make it easier to connect instruments in a sequence.
	 Once source-measure instruments are interconnected through the TSP-Link expansion interface, a computer can access all of the resources of each source-measure instrument through the host interface of any System SourceMeter. A maximum of 32 TSP-Link nodes can be interconnected. Each source-measure module uses one TSP-Link node.

TIMING

Timer	Free-running 47-bit counter with 1 MHz clock input. Reset each time instrument power is turned on. If the instrument is not turned off, the timer is automatically reset to 0 every four years.
Timestamp	TIMER value is automatically saved when each measurement is triggered
Resolution	1 µs
Timestamp accuracy	±100 ppm

GENERAL SPECIFICATIONS

Ethernet	RJ-45 connector, LXI version 1.4 Core 2011, 10/100BaseT, Auto-MDIX
LXI compliance	LXI version 1.4 Core 2011
Expansion interface	 The TSP-Link[®] expansion interface allows TSP-enabled instruments to trigger and communicate with each other Cable type: Category 5e or higher LAN crossover cable 9.84 ft (3 m) maximum between each TSP-enabled instrument
USB control	USB 2.0 Device: USB-TMC488 protocol
USB file system	USB 2.0 Host: Mass storage class device
Power supply	100 VAC to 240 VAC, 50 Hz or 60 Hz (auto sensing), 425 VA maximum
Cooling	Forced air; front and side intakes and rear exhaust
Warranty	1 year
EMC	Conforms to European Union EMC Directive
Safety	NRTL listed to UL 61010-1 and CSA C22.2 No 61010-1 Conforms with European Union EMC Low Voltage Directive
Environment	For indoor use only Altitude: Maximum 6562 ft (2000 m) above sea level Operating: 0 °C to 50 °C, 70% relative humidity up to 35 °C. Derate 3% relative humidity/°C, 35 °C to 50 °C Storage: -25 °C to 65 °C
Dimensions	Rack mount: 1.7 in. high × 19 in. wide × 26.8 in. deep (44 mm × 483 mm × 680 mm)
Weight	13.6 kg (30 lb)

